-3.3V/-5V Differential ECL to +3.3V LVTTL Translator

The MC100EPT25 is a Differential ECL to LVTTL translator. This device requires +3.3 V, -3.3 V to -5.2 V, and ground. The small outline 8–lead package and the single gate of the EPT25 make it ideal for applications which require the translation of a clock or data signal.

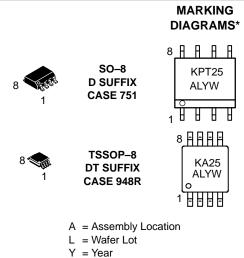
The V_{BB} output allows the EPT25 to also be used in a single–ended input mode. In this mode the V_{BB} output is tied to the D input for a inverting buffer or the \overline{D} input for a non–inverting buffer. If used, the V_{BB} pin should be bypassed to ground with at least a 0.01 μF capacitor.

- 1.1 ns Typical Propagation Delay
- Maximum Frequency > 275 MHz Typical
- Operating Range: V_{CC} = 3.0 V to 3.6 V; V_{EE} = -5.5 V to -3.0 V; GND = 0 V
- 24 mA TTL Outputs
- Q Output Will Default LOW with Inputs Open or at V_{EE}
- V_{BB} Output
- Open Input Default State
- Safety Clamp on Inputs



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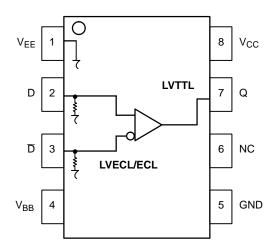


W = Work Week

*For additional information, see Application Note AND8002/D

ORDERING INFORMATION

Device	Package	Shipping
MC100EPT25D	SO–8	98 Units / Rail
MC100EPT25DR2	SO-8	2500 Tape & Reel
MC100EPT25DT	TSSOP-8	100 Units / Rail
MC100EPT25DTR2	TSSOP-8	2500 Tape & Reel



PIN DESCRIPTION

PIN	FUNCTION		
Q	LVTTL Output		
D*, <u>D</u> *	Differential ECL Input Pair		
V _{CC}	Positive Supply		
V _{BB}	Output Reference Voltage		
GND	Ground		
V _{EE}	Negative Supply		
NC	No Connect		

* Pins will default LOW when left open.

Figure 1. 8-Lead Pinout (Top View) and Logic Diagram

ATTRIBUTES

Characteris	Characteristics		
Internal Input Pulldown Resistor	75 kΩ		
Internal Input Pullup Resistor	N/A		
ESD Protection	> 4 kV > 200 V > 2 kV		
Moisture Sensitivity, Indefinite Time C	Out of Drypack (Note 1)	Level 1	
Flammability Rating	Oxygen Index: 28 to 34	UL-94 V-0 @ 0.125 in	
Transistor Count	111 Devices		
Meets or exceeds JEDEC Spec EIA/	JESD78 IC Latchup Test		

1. For additional information, see Application Note AND8003/D.

MAXIMUM RATINGS (Note 2)

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V _{CC}	Positive Power Supply	GND = 0 V	V _{EE} = -5.0 V	3.8	V
V_{EE}	Negative Power Supply	GND = 0 V	V _{CC} = +3.3 V	-6	V
V _{IN}	Input Voltage	GND = 0 V		0 to V _{EE}	V
I _{BB}	V _{BB} Sink/Source			± 0.5	mA
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	0 LFPM 500 LFPM	8 SOIC 8 SOIC	190 130	°C/W °C/W
θ_{JC}	Thermal Resistance (Junction-to-Case)	std bd	8 SOIC	41 to 44	°C/W
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	0 LFPM 500 LFPM	8 TSSOP 8 TSSOP	185 140	°C/W °C/W
θ_{JC}	Thermal Resistance (Junction-to-Case)	std bd	8 TSSOP	41 to 44	°C/W
T _{sol}	Wave Solder	< 2 to 3 sec @ 248°C		265	°C

2. Maximum Ratings are those values beyond which device damage may occur.

			–40°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Мах	Min	Тур	Max	Min	Тур	Max	Unit
IEE	Power Supply Current	8.0	16	25	8.0	16	25	8.0	16	25	mA
V _{IH}	Input HIGH Voltage Single–Ended	-1225		-880	-1225		-880	-1225		-880	mV
V _{IL}	Input LOW Voltage Single–Ended	-1945		-1625	-1945		-1625	-1945		-1625	mV
V_{BB}	Output Voltage Reference	-1525	-1425	-1325	-1525	-1425	-1325	-1525	-1425	-1325	mV
VIHCMR	Input HIGH Voltage Common Mode Range (Note 4)	V _{EE} ·	+ 2.0	0.0	V _{EE}	+ 2.0	0.0	V _{EE} ·	+ 2.0	0.0	V
I _{IH}	Input HIGH Current			150			150			150	μΑ
IIL	Input LOW Current D D	0.5 -150			0.5 -150			0.5 -150			μΑ

NOTE: 100EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfpm is maintained.

3. Input parameters vary 1:1 with GND.

4. VILCHR min varies 1:1 with VEE, VILCHR max varies 1:1 with VCC. The VILCHR range is referenced to the most positive side of the differential input signal.

TTL OUTPUT DC CHARACTERISTICS V _{CC} = 3.3	V; $V_{EE} = -5.5$ V to -3.0 V; GND = 0.0 V; $T_A = -40^{\circ}$ C to 85° C
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Symbol	Characteristic	Condition	Min	Тур	Max	Unit
V _{OH}	Output HIGH Voltage (Note 5)	I _{OH} = -3.0 mA	2.2			V
V _{OL}	Output LOW Voltage (Note 5)	I _{OL} = 24 mA			0.5	V
I _{CCH}	Power Supply Current		6	10	14	mA
I _{CCL}	Power Supply Current		7	12	17	mA

NOTE: 100EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfpm is maintained.

5. All loading with 500 Ω to GND; CL = 20 pF.

AC CHARACTERISTICS V_{CC} = 3.0 V to 3.6 V; V_{EE} = -5.5 V to -3.0 V; GND = 0.0 V (Note 6)

		−40°C		25°C		85°C					
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f _{max}	Maximum Frequency (See Figure 2 F _{max} /JITTER)	275			275			275			MHz
t _{PLH} , t _{PHL}	Propagation Delay to Output Differential	800	1200	1800	800	1100	1600	800	1100	1600	ns
t _{SKPP}	Device-to-Device Skew (Note 7)			500			500			500	ps
^t JITTER	Cycle-to-Cycle Jitter (See Figure 2 F _{max} /JITTER)		0.2	< 1		0.2	< 1		0.2	< 1	ps
V _{PP}	Input Voltage Swing (Differential)	150	800	1200	150	800	1200	150	800	1200	mV
t _r t _f	Output Rise/Fall Times Q, \overline{Q} (0.8 V - 2.0 V)	450 900	600 1160	750 1400	450 900	600 1100	750 1400	450 900	600 1100	750 1400	ps

6. Measured using a 750 mV source, 50% duty cycle clock source. All loading with 500 Ω to GND.

7. Skews are measured between outputs under identical conditions.

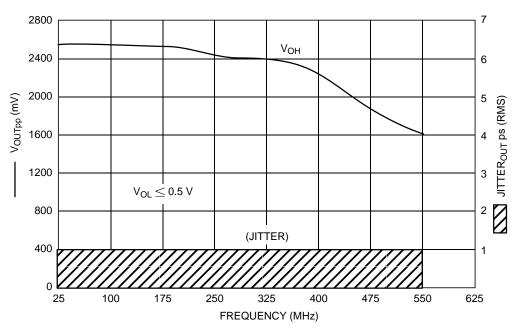


Figure 2. F_{max}/Jitter

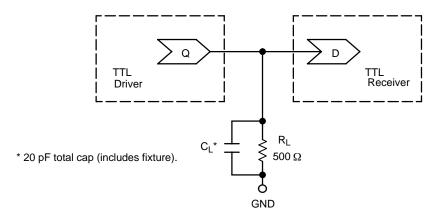


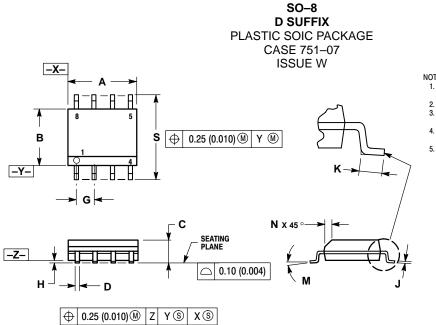
Figure 3. TTL Output Loading Used for Device Evaluation

Resource Reference of Application Notes

- AN1404 _ ECLinPS Circuit Performance at Non–Standard VIH Levels
- AN1405 ECL Clock Distribution Techniques
- AN1406 Designing with PECL (ECL at +5.0 V)
- AN1503 ECLinPS I/O SPICE Modeling Kit
- AN1504 Metastability and the ECLinPS Family
- AN1560 Low Voltage ECLinPS SPICE Modeling Kit
- AN1568 Interfacing Between LVDS and ECL
- AN1596 ECLinPS Lite Translator ELT Family SPICE I/O Model Kit
- AN1650 Using Wire–OR Ties in ECLinPS Designs
- AN1672 The ECL Translator Guide
- AND8001 Odd Number Counters Design
- AND8002 Marking and Date Codes
- AND8020 _ Termination of ECL Logic Devices

For an updated list of Application Notes, please see our website at http://onsemi.com.

PACKAGE DIMENSIONS



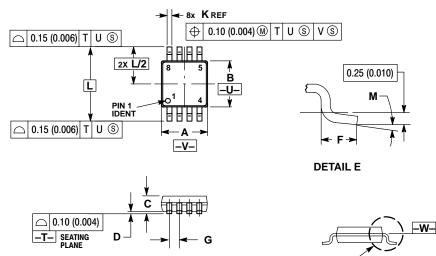
NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI

Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER. DIMENSION A AND B DO NOT INCLUDE MOLD

- PROTRUSION. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER
- SIDE.
- SIDE. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	4.80	5.00	0.189	0.197	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.053	0.069	
D	0.33	0.51	0.013	0.020	
G	1.2	7 BSC	0.050 BSC		
Н	0.10	0.25	0.004	0.010	
J	0.19	0.25	0.007	0.010	
K	0.40	1.27	0.016	0.050	
М	0 °	8 °	0 °	8 °	
Ν	0.25	0.50	0.010	0.020	
S	5.80	6.20	0.228	0.244	

TSSOP-8 DT SUFFIX PLASTIC TSSOP PACKAGE CASE 948R-02 **ISSUE A**



DETAIL E

- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER.
- 3. DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15
- Onto PER SIDE.
 DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010)
- PER SIDE. 5. TERMINAL NUMBERS ARE SHOWN FOR

REFERENCE ONLY. 6. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	2.90	3.10	0.114	0.122	
В	2.90	3.10	0.114	0.122	
С	0.80	0.80 1.10		0.043	
D	0.05	0.15	0.002	0.006	
F	0.40	0.70	0.016	0.028	
G	0.65	BSC	0.026 BSC		
Κ	0.25	0.40	0.010	0.016	
L	4.90	BSC	0.193 BSC		
Μ	0 °	6 °	0°	6 °	

<u>Notes</u>

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